



N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)		
40	0.009 at V _{GS} = 10 V	17		
	0.012 at V _{GS} = 4.5 V	15		

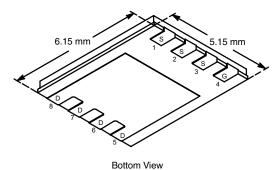
FEATURES

- TrenchFET[®] Power MOSFETS
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile



- PWM Optimized for Fast Switching
- 100 % R_a Tested

PowerPAK SO-8

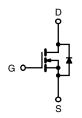


Ordering Information: Si7848DP-T1

Si7848DP-T1—E3 (Lead (Pb)-free)

APPLICATIONS

- DC/DC Converters
 - Synchronous Buck
 - Synchronous Rectifier



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A	= 25 °C, unles	ss otherwise r	noted			
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V_{DS}	40		V	
Gate-Source Voltage		V_{GS}	± 20		V	
Continuous Drain Current (T _{.I} = 150 °C) ^a	T _A = 25 °C	I _D	17	10.4		
Continuous Diain Current (1) = 150 °C)	T _A = 70 °C		13.7	8.3	Α	
Pulsed Drain Current		I _{DM}	50		A	
Avalanche Current	L = 0.1 mH	I _{AS}	30			
Continuous Source Current (Diode Conduction) ^a		I _S	4.5	1.67		
Mariana Dana Diningting	T _A = 25 °C	P _D	5	1.83	W	
Maximum Power Dissipation ^a	T _A = 70 °C		3.2	1.2		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	– 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b,c}		260		60]	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marrian una luncation to Ameleicati	t ≤ 10 sec	R _{thJA}	20	25	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		55	68		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.8	2.2		

a. Surface Mounted on 1" x 1" FR4 Board.
b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

Vishay Siliconix

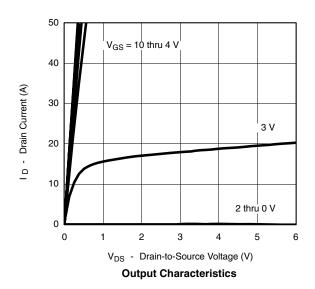


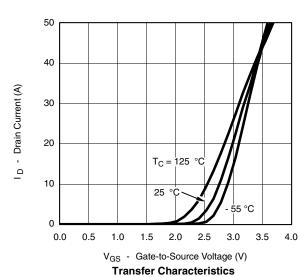
Parameter Symbo		Test Condition	Min	Тур	Max	Unit
Static			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0		3.0	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current		V _{DS} = 40 V, V _{GS} = 0 V			1	μΑ
	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	_{IS} = 40 V, V _{GS} = 0 V, T _J = 55 °C		5	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α
Drain-Source On-State Resistance ^a	_	V _{GS} = 10 V, I _D = 14 A		0.0075	0.009	
	r _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 12 \text{ A}$		0.0095	0.012	Ω
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 14 A		50		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.8 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.1	V
Dynamic ^b			1.	l.	<u>. </u>	
Total Gate Charge	Q_g			18.5	28	
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 14 \text{ A}$		6		nC
Gate-Drain Charge	Q_{gd}			7.5		
Gate Resistance	R_{g}		0.1	0.8	1.1	Ω
Turn-On Delay Time	t _{d(on)}			15	30	
Rise Time	t _r	V_{DD} = 20 V, R_L = 20 Ω		10	20	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 1 A, V_{GEN} = 10 V, R_G = 6 Ω		50	100	ns
Fall Time	t _f			20	40	
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = 2.8 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		30	60	

- Notes a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless noted



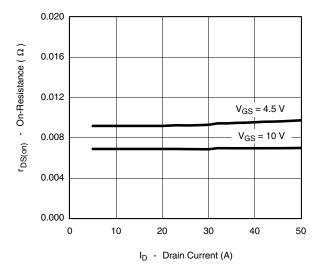




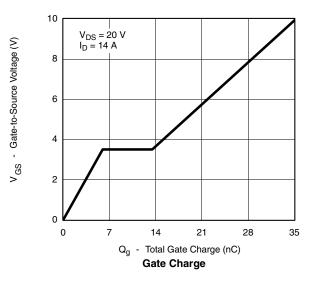




TYPICAL CHARACTERISTICS 25 °C, unless noted



On-Resistance vs. Drain Current



T_J = 150 °C

T_J = 25 °C

10

0.0
0.2
0.4
0.6
0.8
1.0
1.2

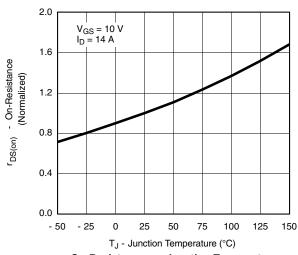
V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

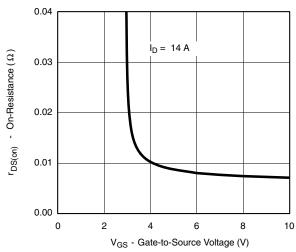
3000 2500 C - Capacitance (pF) Ciss 2000 1500 1000 Coss 500 C_{rss} 0 0 16 24 32 40

V_{DS} - Drain-to-Source Voltage (V)

Capacitance



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

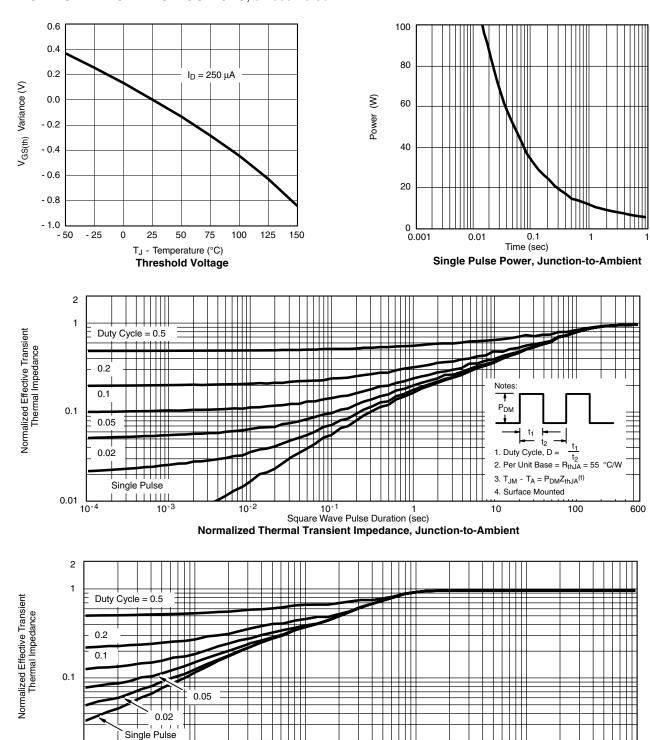
50

- Source Current (A)

Vishay Siliconix

VISHAY

TYPICAL CHARACTERISTICS 25 °C, unless noted



Normalized Thermal Transient Impedance, Junction-to-Case

10-2

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71450.

Square Wave Pulse Duration (sec)

10-1

0.01 L

10⁻³

10



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 Revision: 18-Jul-08